# Very Low Forward Voltage Trench-based Schottky Rectifier

Exceptionally Low  $V_F = 0.39 \text{ V}$  at  $I_F = 5 \text{ A}$ 

#### **Features**

- Fine Lithography Trench-based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- This is a Pb-Free Device

#### **Typical Applications**

- Switching Power Supplies including Notebook / Netbook Adapters, ATX and Flat Panel Display
- High Frequency and DC-DC Converters
- Freewheeling and OR-ing diodes
- Reverse Battery Protection
- Instrumentation

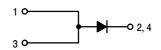
#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94–0 @ 0.125 in
- Weight (Approximately): 1.9 grams
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Maximum for 10 sec



# ON Semiconductor®

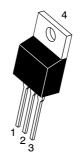
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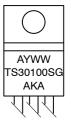
TO-220AB

CASE 221A

STYLE 6



# MARKING DIAGRAMS





I<sup>2</sup>PAK (TO-262) CASE 418D STYLE 3



A = Assembly Location

Y = Year
WW = Work Week
G = Pb-Free Package
AKA = Polarity Designator

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NTST30100SG	TO-220 (Pb-Free)	50 Units/Rail
NTSB30100S-1G	TO-262 (Pb-Free)	50 Units/Rail

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	V
Average Rectified Forward Current (Rated $V_R$ , $T_C = 105^{\circ}C$ )	I <sub>F(AV)</sub>	30	А
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 95°C)	I <sub>FRM</sub>	60	А
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	250	А
Operating Junction Temperature	TJ	-40 to +150	°C
Storage Temperature	T <sub>stg</sub>	-65 to +175	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

# THERMAL CHARACTERISTICS

Rating		Symbol	Value	Unit
Maximum Thermal Resistance	Junction-to-Case Junction-to-Ambient	${\sf R}_{ heta \sf JC} \ {\sf R}_{ heta \sf JA}$	2.0 70	°C/W °C/W

# **ELECTRICAL CHARACTERISTICS**

Rating	Symbol	Тур	Max	Unit
Maximum Instantaneous Forward Voltage (Note 1) $ \begin{aligned} (I_F = 5 \text{ A, } T_J = 25^\circ\text{C}) \\ (I_F = 10 \text{ A, } T_J = 25^\circ\text{C}) \\ (I_F = 30 \text{ A, } T_J = 25^\circ\text{C}) \end{aligned} $	V <sub>F</sub>	0.47 0.55 0.84	- - 0.95	V
$(I_F = 5 \text{ A}, T_J = 125^{\circ}\text{C})$ $(I_F = 10 \text{ A}, T_J = 125^{\circ}\text{C})$ $(I_F = 30 \text{ A}, T_J = 125^{\circ}\text{C})$		0.39 0.51 0.7	- - 0.78	
Maximum Instantaneous Reverse Current (Note 1) $ (V_R = 70 \text{ V}, T_J = 25^{\circ}\text{C}) $ $ (V_R = 70 \text{ V}, T_J = 125^{\circ}\text{C}) $	I <sub>R</sub>	27 11		μA mA
(Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 125^{\circ}C$ )		70 23	1000 45	μA mA

<sup>1.</sup> Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq 2.0\%$ 

#### **TYPICAL CHARACTERISTICS**

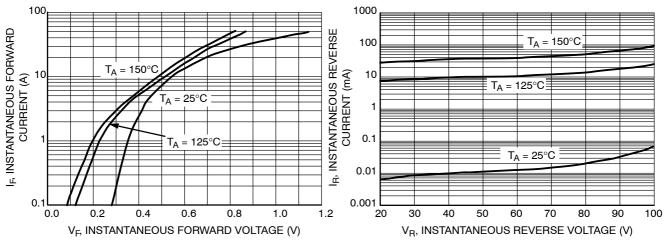


Figure 1. Typical Instantaneous Forward Characteristics

Figure 2. Typical Reverse Characteristics

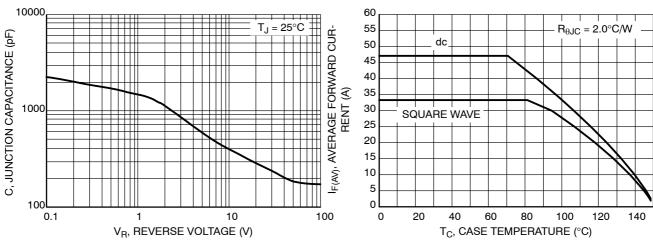


Figure 3. Typical Junction Capacitance

Figure 4. Current Derating, Case

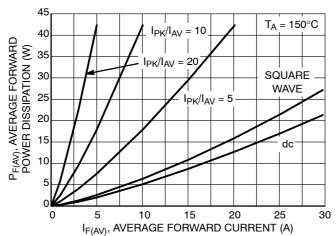


Figure 5. Forward Power Dissipation

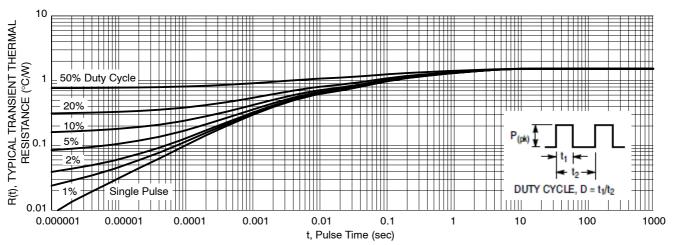
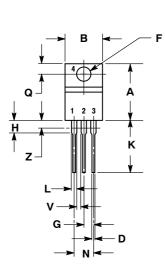
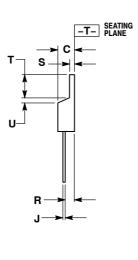


Figure 6. Typical Transient Thermal Response, Junction-to-Case

# **PACKAGE DIMENSIONS**

TO-220 CASE 221A-09 **ISSUE AF** 





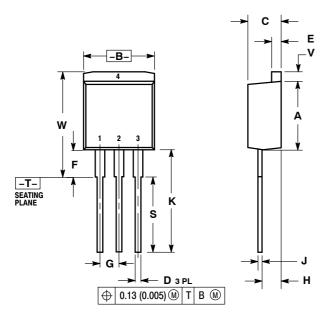
- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.161	3.61	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.014	0.025	0.36	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

- STYLE 6: PIN 1. ANODE 2. CATHODE 3. ANODE 4. CATHODE

#### PACKAGE DIMENSIONS

I<sup>2</sup>PAK (TO-262) CASE 418D-01 ISSUE D



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
   Y14 5M 1982
- 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.335	0.380	8.51	9.65
В	0.380	0.406	9.65	10.31
С	0.160	0.185	4.06	4.70
D	0.026	0.035	0.66	0.89
Ε	0.045	0.055	1.14	1.40
F	0.122 REF		3.10 REF	
G	0.100 BSC		2.54	BSC
Н	0.094	0.110	2.39	2.79
J	0.013	0.025	0.33	0.64
K	0.500	0.562	12.70	14.27
S	0.390 REF		9.90	REF
٧	0.045	0.070	1.14	1.78
w	0.522	0.551	13.25	14.00

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